



## SBR1U400P1

1.0A SBR SURFACE MOUNT SUPER BARRIER RECTIFIER PowerDI123

### **Features**

- Ultra Low Forward Voltage Drop
- Low Leakage Current
- Superior Reverse Avalanche Capability
- **Excellent High Temperature Stability**
- Patented Interlocking Clip Design for High Surge Current Capacity
- Patented Super Barrier Rectifier Technology (SBR<sup>®</sup>)
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Mechanical Data**

- Case: PowerDI<sup>®</sup>123 •
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.018 grams (Approximate)

PowerDI123



Top View

## Ordering Information (Note 4)

Part Number	Case	Packaging
SBR1U400P1-7	PowerDI123	3000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. Notes: 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



SDE = Product Type Marking Code  $Y\overline{M}$  = Date Code Marking Y = Year (ex: F = 2018)M = Month (ex: 9 = September)

Date Code Key												
Year	20	15	2016		2017	2	018	2019	)	2020		2021
Code	(	0	D		E		F	G		Н		
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> Vrwm V <sub>RM</sub>	400	V
Average Rectified Output Current (See Figure 1)	lo	1.0	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	40	А

# **Thermal Characteristics**

Notes:

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Junction to Ambient (Note 5)	R <sub>0JA</sub>	217	°C/W
Maximum Thermal Resistance Junction to Ambient (Note 6)	R <sub>0JA</sub>	138	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

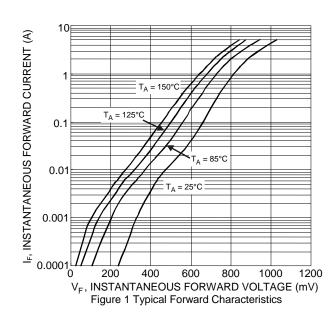
### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

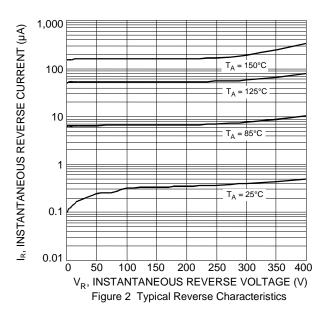
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage	VF		0.82	0.90 0.80	V	I <sub>F</sub> = 1.0A, T <sub>J</sub> = +25°C I <sub>F</sub> = 1.0A, T <sub>J</sub> = +125°C
Reverse Current (Note 7)	I <sub>R</sub>	_	 0.013 0.073	0.05 0.36 2	mA	$V_R = 400V, T_J = +25^{\circ}C$ $V_R = 400V, T_J = +85^{\circ}C$ $V_R = 400V, T_J = +125^{\circ}C$
Reverse Recovery Time	t <sub>RR</sub>	_	—	85	ns	I <sub>F</sub> = 0.5A, I <sub>R</sub> = 1A, I <sub>RR</sub> = 0.25A

5. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.

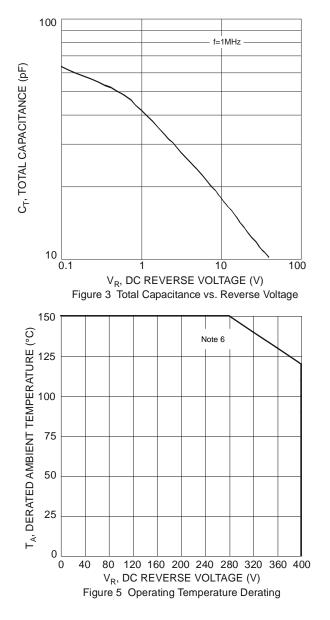
6. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.

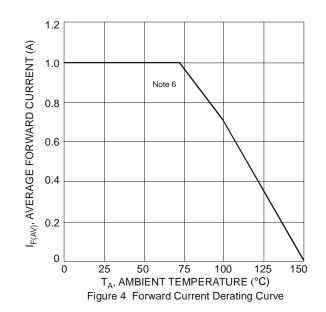
7. Short duration pulse test used to minimize self-heating effect.









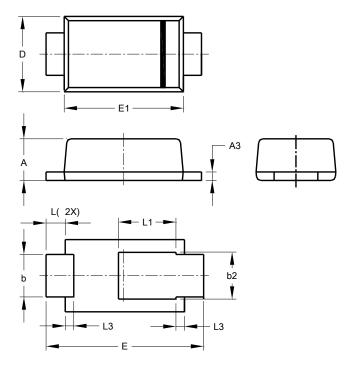




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI123

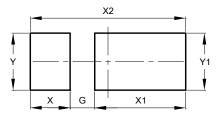


PowerDI123						
Dim	Min	Max	Тур			
Α	0.93	1.00	0.98			
A3	0.15	0.25	0.20			
b	0.85	1.25	1.00			
b2	1.025	1.125	1.10			
D	1.63	1.93	1.78			
Е	3.50	3.90	3.70			
E1	2.60	3.00	2.80			
L	0.40	0.50	0.45			
L1	1.25	1.40	1.35			
L3	0.125	0.275	0.20			
All Dimensions in mm						

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI123



Dimensions	Value (in mm)
G	0.65
Х	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50



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